

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT3194679

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
EON SILICON SOLUTION, INC.	01/15/2015
RECEIVING PARTY DATA	
Name:	ESIGMA TECHNOLOGY CORPORATION LIMITED
Street Address:	NO. 2220, NO. 2 FLOOR, NO. 7, CHUANGXIN ROAD
Internal Address:	ZHONGGUANCUN SCIENCE PARK CHANGPING SECTOR, CHANGPING DISTRICT
City:	BEIJING P.R.
State/Country:	CHINA
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	12761460
CORRESPONDENCE DATA	
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SIGNATURE:	/ARLEN L. OLSEN/
DATE SIGNED:	01/23/2015
Total Attachments: 2	
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ASSIGNMENT OF UTILITY PATENT APPLICATION

Title of Invention: METHOD FOR MANUFACTURING NONVOLATILE SEMICONDUCTOR MEMORY DEVICE STRUCTURE

This assignment is directed to the attached application, or (if following box is checked):

United States application or PCT international application number 12/761,460 filed on APR. 16, 2010.

Whereas, EON SILICON SOLUTION, INC., having a place of business at 6F-2, NO. 30, TAI-YUAN STREET, CHU-PEI, HSIN-CHU, TAIWAN (R.O.C.) (herein referred to as "EON") is an assignee of record of certain inventions, improvements, and discoveries (herein referred to as the "Invention") disclosed in the above-identified application;

Whereas, EON desires to grant to **ESIGMA TECHNOLOGY CORPORATION LIMITED**, having a place of business at **NO. 2220, NO. 2 FLOOR, NO. 7 CHUANGXIN ROAD, ZHONGGUANCUN SCIENCE PARK CHANGPING SECTOR, CHANGPING DISTRICT, BEIJING P.R. CHINA** (herein referred to as "ESIGMA"), EON's entire worldwide right, title, and interest in and to the Invention and in and to any and all patent applications and patents directed thereto;

Whereas, **ESIGMA** desires to acquire from **EON** EON's entire worldwide right, title, and interest in and to the Invention and in and to any and all patent applications and patents directed thereto;

Now, therefore, for good and valuable consideration, the receipt and sufficiency thereof being hereby acknowledged, **EON** ("ASSIGNOR") hereby sells or has sold, assigns or has assigned, and otherwise transfers or has transferred to **ESIGMA** (the "ASSIGNEE"), its successor, legal representatives, and assigns, EON's entire worldwide right, title, and interest in and to the Invention, the above-identified United States patent application, and any and all other patent applications and patents for the Invention which may be applied for or granted therefor in the United States and in all foreign countries and jurisdictions, including all divisions, continuations, reissues, reexaminations, renewals, extensions, counterparts, substitutes, and extensions thereof, and all rights of priority resulting from the filing of such applications and granting of such patents. In addition, **EON** hereby authorizes and requests the Director of the United States Patent and Trademark Office to issue any United States Patent, and foreign patent authorities to issue any foreign patent, granted for the Invention, to **ESIGMA**, its successors, legal representatives, and assigns, **EON's** entire worldwide right, title, and interest in and to the same to be held and enjoyed by **ESIGMA**, its successors, legal representatives, and assigns to the full end of the terms for which any and all such patents may be granted, as fully and entirely as would have been held and enjoyed by **EON** had this Assignment not been made; and **EON** agrees to execute any and all documents and instruments and perform all lawful acts reasonably related to recording this Assignment or perfecting title to the Invention and all related patents and applications, in **ESIGMA**, its successors, legal representatives, and assigns, whenever requested by **ESIGMA**, its successors, legal representative, or assigns.

EON acknowledges its prior and ongoing obligations to sell, assign, and transfer the rights under this Assignment to **ESIGMA** and is unaware of any reason why it may not have the full and unencumbered right to sell, assign, and transfer the rights hereby sold, assigned, and transferred, and has not executed, and will not execute, any document or instrument in conflict herewith. **EON** also hereby grants to **ESIGMA**, its successors, legal representatives, and assigns, the right to insert in this Assignment any

further identification (including, but not limited to, patent Application Number) which may be necessary or desirable for recordation of this Assignment.

EON SILICON SOLUTION, INC.

ESIGMA TECHNOLOGY CORPORATION
LIMITED

By: PAULING CHEN

By: JUN CHEN

Signature: *Pauling Chen*

Signature: *Chen Jun*

Date: 2015.1.15

Date: 2014.12.18